

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IAUT300N08S5N012	**Issued**	15. May 2021
MA#	MA005344602		
Package	PG-HSOF-8-1	**Weight***	777.38 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	7.727	0.99	0.99	9940	9940
leadframe	inorganic material	phosphorus	7723-14-0	0.126	0.02		162	
	non noble metal	iron	7439-89-6	0.421	0.05		541	
	non noble metal	copper	7440-50-8	420.040	54.03	54.10	540329	541032
wire	non noble metal	aluminium	7429-90-5	20.278	2.61	2.61	26085	26085
encapsulation	inorganic material	zincoxide	1314-13-2	3.155	0.41		4059	
	miscellaneous	miscellaneous	-	12.621	1.62		16235	
	plastics	epoxy resin	-	47.329	6.09		60883	
	inorganic material	silicondioxide	60676-86-0	252.422	32.47	40.59	324708	405885
leadfinish	non noble metal	tin	7440-31-5	6.479	0.83	0.83	8334	8334
plating	inorganic material	phosphorus	7723-14-0	0.001			2	
	non noble metal	nickel	7440-02-0	0.526	0.07	0.07	677	679
solder	non noble metal	tin	7440-31-5	0.125	0.02		161	
	noble metal	silver	7440-22-4	0.156	0.02		201	
	non noble metal	lead	7439-92-1	5.973	0.77	0.81	7683	8045
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com